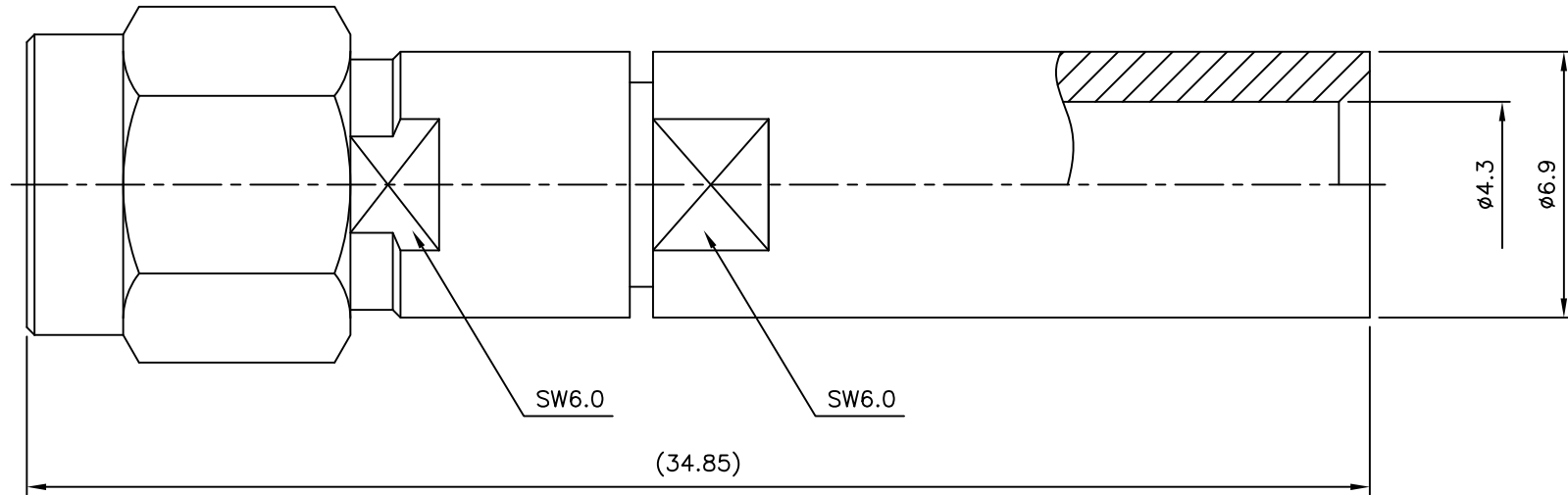


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2018.11.02.
1	GASKET 제거 및 PIN 도금 두께 변경	S.Y.EUN	I.C.KIM	2019.02.12.
2	특성개선으로 인한 PIN 변경	S.Y.EUN	I.C.KIM	2020.07.23.

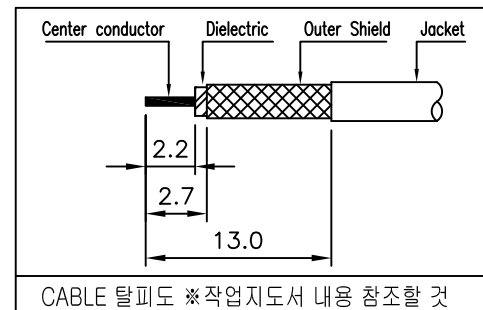


ELECTRICAL DATA

1. IMPEDANCE : 50ohm
2. FREQUENCY RANGE : DC~40GHz
3. VSWR (Max) : 1.2

Mate compatible table	
SMA [~18GHz]	Mate
3.5mm [~26.5GHz]	
2.92mm(K) [~40GHz]	
2.4mm [~50GHz]	Mate
1.85mm(V) [~65GHz]	

Un mate



8	CLAMP	1	MBsBD C3604BD-F	Nickel Plate	DBN00212-5/4
7	CAP	1	SUS	Passivated	DCU00006-5/1
6	SPRING RING	1	SUS304	부동태 처리	DSR00002-5/1
5	INSERT	1	MBsBD C3604BD-F	Gold Plate	DIS00282-5/2
4	INSERT	1	SUS	Passivated	DIS00281-5/5
3	INSULATOR	1	PEEK		DIN02942-N/B
2	GASKET	1	SILICONE RUB		DGK00004-N/1
1	CONTACT	1	BeCu C17300	Gold Plate 1.3μm	DCT03945-5/4 DCT03945-5/6
1	BODY	1	SUS	Passivated	DBD04399-5/5
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2020. 07. 23.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY I.C.KIM			
MATERIAL _____		CHECKED BY		TITLE SMA 2.92mm CABLE PS MUA165SD	
		DRAWN BY S.Y.EUN			
FINISH _____	SCALE 5/1	UNIT mm		A4	DWG NO. CN03779-7/6
					REVISION 2

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